



Four Layers PCB with Blind Buried Holes and Ceramic Substrate for Highreliability Applications

Basic Information

Place of Origin: China Brand Name: GS

Model Number: GS4CMMKBMinimum Order Quantity: 1 PCS

• Price: USD+negotiable+pcs

Packaging Details: 20*20*10cm
Delivery Time: 5-15 days
Payment Terms: T/T

• Supply Ability: 1+pcs+per days



Product Specification

Highlight: Blind Buried Holes PCB manufacturing,
 Four layers PCB manufacturing

PCB Manufacturing Four Layers Of Blind Buried Holes



Product Description

Specialized PCB manufacturing featuring four layers with blind and buried vias technology for advanced circuit board applications.

Key Features

Four-layer PCB construction with blind/buried vias

High-density interconnect technology

Enhanced signal integrity and reliability

Space-saving multilayer design

Applications

High-frequency PCBs

Impedance controlled circuits

RF circuit boards

Advanced electronic systems

Related Technologies

Specialty PCB Heavy copper PCB Ceramic PCB Flexible circuit boards Metal core PCB High-temperature PCBs Custom PCB design Thick copper PCB High-reliability PCBs Advanced PCB fabrication







